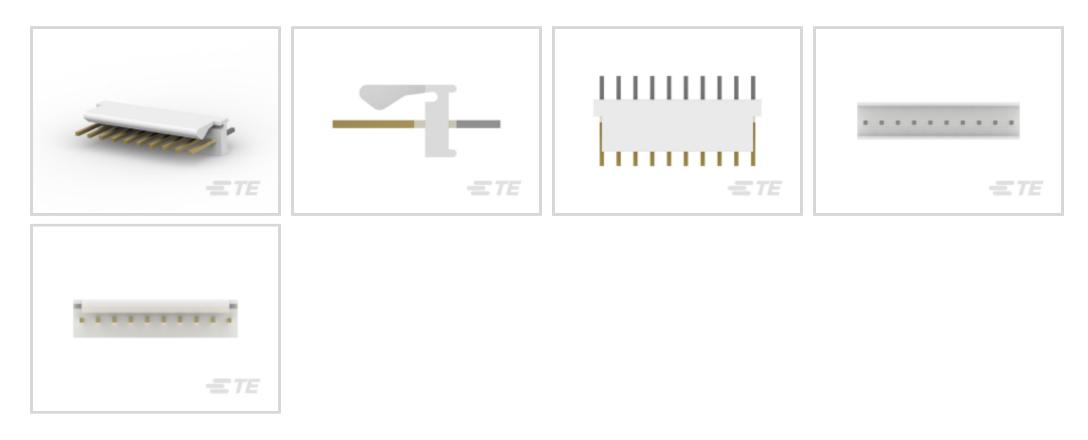
4-641126-0 <

MTA 100

TE Internal #: 4-641126-0 PCB Mount Header, Vertical, Wire-to-Board, 10 Position, 2.54 mm [. 1 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, Signal, MTA 100

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles > PCB Header: Polyester, Vertical, Unshrouded, No Mating Alignment



Connector System: Wire-to-Board

Number of Positions: 10

Number of Rows: 1

Centerline (Pitch): 2.54 mm [.1 in]

PCB Mount Orientation: Vertical

All PCB Header: Polyester, Vertical, Unshrouded, No Mating Alignment (332)



Features

Product Type Features

Connector System	Wire-to-Board
Header Type	Partially Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Configuration Features	
Number of Positions	10
Number of Rows	1
PCB Mount Orientation	Vertical
Electrical Characteristics	
Operating Voltage	250 VAC
Body Features	

PCB Mount Header, Vertical, Wire-to-Board, 10 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, Signal, MTA 100



And Contact LayoutInlineContact Mating Area Length7.49 mm[.295 in]Mating Square Post Dimension6.4 mm[.025 in]PCB Contact Termination Area Plating Material Thickness3.81 – 8.89 µm[150 – 350 µin]Contact Underplating Material Thickness1.27 µm[50 µin]Contact Termination Area Plating Material FinishMatteContact Shape & FormSquareContact Mating Area Plating Material FinishMatteContact Underplating Material FinishSquareContact Mating Area Plating Material FinishSightContact Mating Area Plating Material FinishSightContact Underplating Material FinishSightContact Underplating Material FinishSightContact Mating Area Plating Material FinishSightContact Underplating Material FinishSightContact Underplating Material FinishSightContact Material FinishSightContact Material FinishSightContact Material FinishSightContact Termination Area Plating MaterialSightContact Material FinishSightContact Material FinishSightContact Material FinishSightContact Material FinishSightContact Termination Area Plating MaterialSightContact Material FinishSightContact Material FinishSightContact Material FinishSightContact Material FinishSightContact Material FinishSightContact Material FinishSightContact	Primary Product Color	Natural	
Autor yContact Mating Area Length7.49 mm[.295 in]Mating Square Post Dimension.64 mm[.025 in]PCB Contact Termination Area Plating Material Thickness3.81 – 8.89 µm[150 – 350 µin]Contact Underplating Material Thickness.127 µm[50 µin]Contact Mating Area Plating Material Thickness.38 µm[15 µin]PCB Contact Termination Area Plating Material FinishMatteContact Shape & FormSquareContact Mating Area Plating Material FinishMatteContact Underplating Material FinishBrightContact Underplating MaterialNickelContact Underplating MaterialNickelContact Underplating MaterialSiguareContact Underplating MaterialSiguareContact Underplating MaterialSiguareContact Underplating MaterialSiguareContact Termination Area Plating MaterialSiguareContact Mating Area Plating MaterialSiguareContact Underplating MaterialSiguareContact Termination Area Plating MaterialSiguareContact MaterialSiguareContact MaterialSiguareContact MaterialSiguareContact MaterialSiguareContact MaterialSiguareContact Termination AreaSiguareContact Termination AreaSiguareContact MaterialSiguareContact MaterialSiguareContact Termination AreaSiguareContact Termination AreaSiguareContact MaterialSiguareContact Materia	Contact Features		
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PCB Contact Termination Area Plating Material Thickness3.81 – 8.89 μm[150 – 350 μin]Contact Underplating Material Thickness1.27 μm[50 μin]Contact Mating Area Plating Material Thickness.38 μm[15 μin]PCB Contact Termination Area Plating Material FinishMatteContact Shape & FormSquareContact Mating Area Plating Material FinishBrightContact Mating Area Plating Material FinishBrightContact Mating Area Plating Material FinishNickelContact Underplating MaterialNickelContact Underplating MaterialTinContact Shape & Area Plating MaterialCopper AlloyContact Base MaterialGoldContact Mating Area Plating MaterialFinContact Mating Area Plating MaterialFinContact Due De	Contact Mating Area Length	7.49 mm[.295 in]	
Kontact Underplating Material Thickness1.27 µm[50 µin]Contact Mating Area Plating Material Thickness.38 µm[15 µin]PCB Contact Termination Area Plating Material FinishMatteContact Shape & FormSquareContact Mating Area Plating Material FinishBrightContact Underplating MaterialNickelPCB Contact Termination Area Plating MaterialNickelContact Underplating MaterialNickelContact Underplating MaterialTinContact Base MaterialCopper AlloyContact Mating Area Plating MaterialBightContact TypePin	Mating Square Post Dimension	.64 mm[.025 in]	
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Contact Underplating MaterialNickelPCB Contact Termination Area Plating MaterialTinContact Base MaterialCopper AlloyContact Mating Area Plating MaterialGoldContact TypePin	Contact Shape & Form	Square	
PCB Contact Termination Area Plating MaterialTinContact Base MaterialCopper AlloyContact Mating Area Plating MaterialGoldContact TypePin	Contact Mating Area Plating Material Finish	Bright	
Contact Base Material Copper Alloy Contact Mating Area Plating Material Gold Contact Type Pin	Contact Underplating Material	Nickel	
Contact Mating Area Plating Material Gold Contact Type Pin	PCB Contact Termination Area Plating Material	Tin	
Contact Type Pin	Contact Base Material	Copper Alloy	
	Contact Mating Area Plating Material	Gold	
Contact Current Rating (Max) 5 A	Contact Type	Pin	
	Contact Current Rating (Max)	5 A	

Termination Features

Square Termination Post & Tail Dimension	.64 mm[.025 in]	
Termination Post & Tail Length	3.56 mm[.14 in]	
Termination Method to Printed Circuit Board	Through Hole - Solder	
Nechanical Attachment		
Mating Alignment Type	Polarization	
Mating Retention	With	
Panel Mount Feature	Without	
Mating Retention Type	Friction Lock	
Connector Mounting Type	Cable Mount (Free-Hanging)	
Mating Alignment	With	
PCB Mount Alignment	Without	
PCB Mount Retention	Without	
lousing Features		
Housing Material	Polyester - GF	
Centerline (Pitch)	2.54 mm[.1 in]	

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PCB Mount Header, Vertical, Wire-to-Board, 10 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, Signal, MTA 100



Dimensions

Connector Length	27.94 mm[1.1 in]	
Connector Height	7.87 mm[.31 in]	
PCB Thickness (Recommended)	1.6 mm[.063 in]	
Usage Conditions		
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]	
Operation/Application		
Circuit Application	Signal	
Industry Standards		
CSA Rating	Certified	
Agency/Standard	CSA, UL	
Approved Standards	CSA LR7189, UL E28476	
UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Quantity	1	
Packaging Type	Package	

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Hand solderable with lead free solder

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these

PCB Mount Header, Vertical, Wire-to-Board, 10 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, Signal, MTA 100

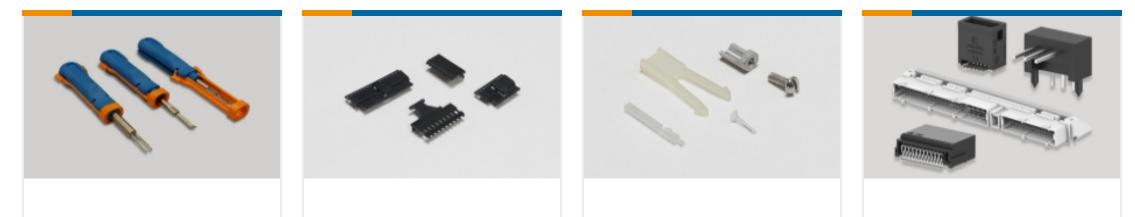


limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | MTA 100



Insertion & Extraction Tools(2)	PCB Connector Covers(107)	PCB Connector Keying(1)	PCB Headers & Receptacles(1181)
		A A A A	
Standard Rectangular Connectors (1718)	Wire-to-Board Connector Assemblies & Housings(1)	Wire-to-Board Connector Contacts(18)	

Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_4-641126-0_AC.2d_dxf.zip

English

Customer View Model

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ENG_CVM_CVM_4-641126-0_AC.3d_igs.zip

English

Customer View Model ENG_CVM_CVM_4-641126-0_AC.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages MTA, CST-100 II, SL-156 and AMP Economy Power (EP) Connectors

English

Product Specifications Application Specification

English

Product Environmental Compliance MD_4-641126-0_063020152339_dmtec

English

MD_4-641126-0_063020152339_dmtec

English

Agency Approvals Agency Approval Document

English